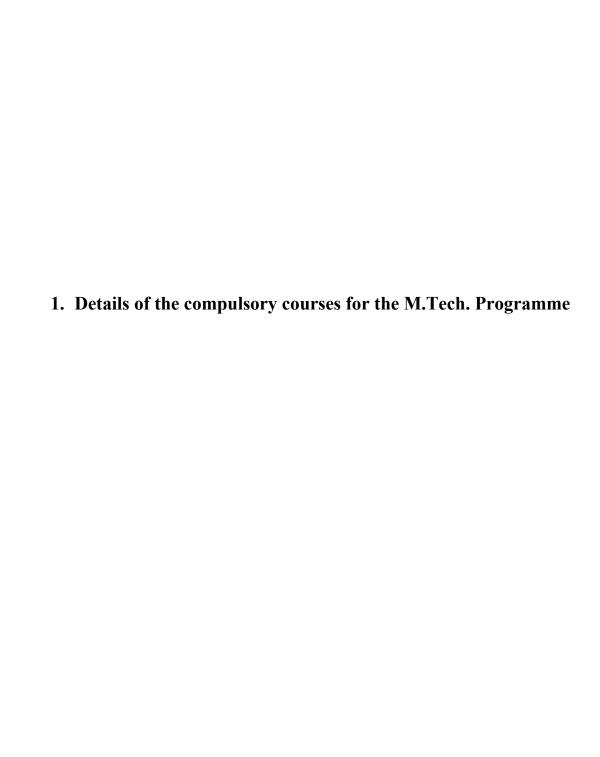
PG Courses at the Department of Materials Science & Engineering IIT Kanpur

This document contains following information

- 1. Details of the compulsory courses for the M.Tech. Programme
- 2. Details of the courses for each of the three streams
 - a. Structure-Characterization-Property
 - b. Metals Processing
 - c. Functional Materials
- 3. Details of the courses other than the above three streams

Updated on 12th APRIL 2022



Department of Materials Science and Engineering Indian Institute of Technology Kanpur

Course Name: Structure and Characterization of Materials

Credits: 3-0-0-4

Course No: MSE 615

Prerequisite: None

Category: Compulsory course for all M.Tech. students of MSE Department, to

be offered in odd semester

Course Contents:

Basic crystallography and crystal structures (8 Lectures hours) Lecture	Hours
Periodic patterns, Lattices, Motif, Unit cells, Crystal structure, Primitive and Non-	1
primitive cells	
Symmetry elements and point group notations	1
Crystal systems and Bravais lattices	1
Crystallographic directions and planes, Miller indices and Weiss zone law	1
Streographic projections	1
Bonding in materials and atomic packing in metals, co-ordination number concepts	1
Covalent bonding, glasses and polymers	2
V	e Hours
Point defects and their role in materials Processing, performance and failure	1
Ionically bonded structures: Pauling's rules and some examples	2
Point defects: thermodynamics, schottkey and Frenkel defect, Kroger-Vink notation,	2
defect interactions	
Dislocations, burgers vector, types of dislocations	1
Dislocation movement, slip systems, energetics of dislocations and their interactions	2
Planar defects: stacking faults, grain boundaries (low angle and high angle), anti-phase	2
domain boundaries, Twinning	
Surface defects with relevance to thin films	1
Non-equilibrium structures such as metallic glasses	1
Diffraction and Imaging (14 Lectures hours) Lecture	Hours
Phenomena of diffraction	1
Radiation-matter Interactions and response signals	1
X-ray diffraction: powder diffraction, phase identification, Scherrer formula, strain and	2
grain size determination	
Fundamentals of Imaging: magnification, resolution, depth of field and depth of focus,	1
aberration and astigmatism	
Optical microscopy, stereology basics and quantitative analysis	2
Fundamentals of SEM: imaging modes, image contrast, illustrative applications	2
Imaging with TEM: Contrast mechanisms, BF, DF, Weak beam DF images	1
TEM application in crystal defect analysis	1

Electron diffraction in TEM and appl	ications		1
STM, AFM and nanoindentation			2
Spectroscopic Techniques	(4 Lectures hours)	Lectur	re Hours
Fundamental basis of Spectroscopic a	analysis		1
EDS and WDS, EPMA applications			1
X ray Photon Spectroscopy and Auge	er electron spectroscopy		1
SIMS and EELS			1
Thermal Analysis Techniques	(2 Lectures hours)	Lectur	re Hours
DSC/DTA/TGA/Dilatometry			2
TOTAL LECTURE HOURS			40

References:

- 1. Crystals and Crystal structures, R.J.D. Tilley, John Wiley and Sons, 2006
- 2. Materials Science and Engineering W.D. Callister, Jr. Wiley India(P) Ltd., 2007
- 3. Materials Science and Engineering, G.S. Upadhyaya and Anish Upadhyaya, Viva books, 2010
- 4. Fundamentals of Materials Science-the microstructure-property relationship using metals as model systems, E.J. Mittemeijer, Springer, 2010
- 5. Microstructural Characterization of Materials D. Brandon and W.D. Kaplan, John Wiley and Sons, 2008
- 6. Science of Microscopy, P.W. Hawkes and J.C.H. Spence, Springer, 2007
- 7. Scanning Electron Microscopy & X-Ray Microanalysis, J.Goldstein et.al, Springer, 2003
- 8. Transmission Electron Microscopy B.D.Williams & C.B.Carter, Springer, 2009
- 9. Surface Analysis methods in materials science, Editors: D.J.O'Connor, B.A. Sextton, R.St. C. Smart, Springer, 2003.
- 10. Materials Characterisation Techniques, S. Zhang, Lin Li and Ashok Kumar, CRC Press, 2009

Department of Materials Science and Engineering Indian Institute of Technology Kanpur

Course Name: Transport Phenomena

Credits: 3-0-0-0-4

Course No: MSE 626

Prerequisite: None

Category: Compulsory course for all M.Tech. students of MSE Department,

to be offered in odd semester

Course Contents:

1. Fluid dynamics (7 Lectures)

Introduction to Transport phenomena in materials processing	1L
Newton's law of viscosity, equation of continuity, Navier Stokes equations	2L
Macroscopic mass and energy balance;	1.5
Characteristics of industrial flows	0.5L
Numerical problems on above topics of interest to metals and materials processing	2L

2. Heat transfer (16 lectures)

2. That transfer (To rectures)	
Fundamentals of conduction heat transfer; Laws and equations; Steady and unsteady heat	2L
conduction	
Numerical problems on conductive heat transfer	3L
Fundamentals of convective heat transfer; free and forced convective heat transfer, Convective	1L
heat transfer rate laws and heat transfer coefficient	
Problems on Convective heat transfer	2L
Fundamentals of Radiation heat transfer and rate laws; view factors	3L
Problems on Radiation heat transfer	1L
Application of heat transfer in: Heat treatment, solidification, cooling of slabs, heat flow	3L
through refractory walls etc.	

3. Mass Transfer (16 lectures)

Fundamentals of diffusion; rate laws, Uphill diffusion and Kirkendal's effect, steady and	4L
unsteady diffusion	
Numerical problems on diffusion mass transfer	2L
Fundamentals of convective mass transfer; free and forced convective mass transfer transfer,	2L
Convective mass transfer, rate laws and mass transfer coefficient	
	1
Problems on Convective mass transport	2L
	CT

Application of mass transfer in: case hardening, doping of semi conductors, homogenization, oxidation, absorption/desorption of gases in liquid metals.

Recommended Text books:

- 1. Transport phenomena: D. R. Geiger and G. H. Poirier
- 2. Transport phenomena: D. R. Gaskel
- 3. Engineering in process metallurgy: R.Guthrie
- 4. Mass transport in solids and fluids: D. S. Wilkinson

Recommended Reference books:

- 1. Diffusion in solids: P. G. Shewman
- 2. Atom movements diffusion and mass transport in solids: J. Philibert
- 3. Diffusion in solids: field theory, solid-state principles, and applications: M. E. Glicksman

Department of Materials Science and Engineering Indian Institute of Technology Kanpur

Course Name: Thermodynamics of Materials

Credits: 3-0-0-0-4

Course No: MSE 616

Prerequisite: None

Category: Compulsory course for all M.Tech. students of MSE Department,

to be offered in odd semester

Course Content

Topics	No of Lectures
Thermodynamic systems and variables.	1
First, second and third laws of thermodynamics.	7
Statistical interpretation of entropy.	2
Free energy functions and criteria for equilibrium.	2
Thermodynamics of solutions. Ideal and non-ideal solutions, Partial and molar quantities	2
Quasi-chemical model and regular solutions,	2
Polynomial expressions for excess Gibbs energy of mixing for binary and higher order solutions. Multi-component dilute solutions and interaction parameters.	2
Chemical reaction equilibrium, equilibrium constant; applications to materials and metallurgical systems.	4
Electrochemical systems, cell reactions and EMF, Formation and concentrations cells.	3
Phase rule and binary phase diagrams	2
Free energy composition diagrams	3
Phase equilibrium calculations	5
Introduction to ternary phase diagrams.	1
Thermodynamics of interfaces; Surface tension and surface energy	2
Absorption and adsorption; Gibbs Thompson effect	2
TOTAL LECTURE HOURS:	40

Suggested Books:

- 1. Chemical Thermodynamics of Materials by C.H.P. Lupis
- 2. Introduction of Metallurgical Thermodynamics by D.R. Gaskell
- 3. Thermodynamics of Solid by R.A. Swalin
- 4. Physical Chemistry of Metals by L.S. Darken and R.W. Gurry

Department of Materials Science and Engineering Indian Institute of Technology Kanpur

Course Name: Mathematics and Computational Methods

Credits: 3-0-0-0-4

Course No: MSE 617

Prerequisite: None

Category: Compulsory course for all M.Tech. students of MSE Department,

to be offered in odd semester

Course Content

S. No	Topics	# of Lectures
1	Introduction of functions, vectors, matrices	1
2	Partial Differentiation (Total differentiation, Maximum and minimum: method of Lagrange multipliers, Change of variables: Legendre transformation, Differentiation of integral; Leibniz rule)	2
3	Multiple Integration (Change of variable: Jacobian, Surface and volume integrals)	2
4	Vectors (Geometry: Lines and planes, Directional derivative, gradients (fields, equipotential, grad, normal to surface, curl, div), Line integration (conservative fields, potential, exact differentiation), Green, Stokes, Div and Curl theorems	4
5	Coordinate Transformation (Linear transform, Orthogonal transform, Eigen values: diagonalization of matrix)	3
6	Ordinary differential equations (Linear first order, Second order: constant coefficient and zero right hand side, Second order: constant coefficient and non zero right hand side)	4
7	Statistics a. Introduction to random experiment, computing probability of an event,	12
	conditional probability and independence of events b. Optimum design of experiments; smoothening and reconciliation of data c. Concept of distribution, parameters of distributions; moment generating functions d. Regression analysis (linear and non linear) e. Confidence intervals, Hypothesis testing f. Error analysis	

8	Numerical Techniques	12
	a. Roots of a equation (Bisection, Newton raphson) (1L)	
	b. Integration (IL)	
	c. Solution of linear equations (one exact, one iterative method) (3L)	
	d. Interpolation and extrapolation (1L)	
	e. Solution of a differential equation by finite difference method (4L)	
	Total	40

Suggested Books:

- Mathematical Methods in Physical Sciences, Mary L. Boas
 Numerical Methods in Engineering, S. K. Gupta

2. Details of the courses for each of the three streams

Stream: Structure-Characterization-Property

Sl. No.	Course Title
1	MSE638 Symmetry and Properties of Crystals
2	MSE 694N Nanostructures and Nanomaterials: Characterization and Properties
3	MSE 639 Interfaces and Materials Properties
4	MSE 676 Materials Failure: Analysis and Prevention
5	MSE 642 Microscopy and Microanalysis of Materials
6	MSE 658 Dislocations and Plasticity

MSE638 Symmetry and Properties of Crystals

Course structure and credits : 3-0-0-4 Prerequisite : Consent of Instructor

Objectives

At the end of the course the student should be able to attain the following objectives.

- 1. A thorough understanding of crystallographic symmetry in 2-D, which will include the 2D lattices, point groups and plane groups
- 2. An understanding of the basis of Bravais Lattices, 3D point groups and space groups.
- 3. An overview of tensors and their use in the representation of the physical properties of crystals.
- 4. Applications to pyroelectricity, dielectric constant, piezoelectricity, elasticity and other symmetry dependent properties, such as, optical properties, conductivity, ferroelectricity.

Suggested books (Complete references)

- 1. M.J. Buerger, Elementary Crystallography.
- 2. International Tables of Crystallography A, International Union of Crystallography
- 3. J. F. Nye, Physical Properties of Crystals (1995), Oxford Science Publications
- 4. D.R. Lovett, Tensor Properties of Crystals (1999), Institute of Physics Publishing
- 5. Robert E. Newnham, "Properties of Materials: Anisotropy, Symmetry, Structure", Oxford Pr.

Lecture Outline

TOPICS	No. of Lectures
Introduction	1
- Symmetries in 1D, 2D and 3D	
- Examples of patterns showing various symmetries	
Symmetries and Lattices in 2D space	2
- Operations of Translation, Rotation and Reflection, standard	
symbols	
- Lattices and Unit Cells	
- Permissible rotational symmetries	
- Derivation of lattices: oblique, rectangular, centred rectangular,	
square, hexagonal	
Point Groups in 2D	4
- Set of symmetry operations	
- Group Theory Essentials	
- Evolution of 2D crystallographic point groups	
2D Space Groups (Plane Groups)	6
- Glide Planes: combination of lattice translation and reflection	· ·
- Derivation of all the 17 plane groups	
- Understanding the Plane Group entries in the International Tables	
of Crystallography	
3D Point Groups	4
- Combination of rotation axes in 3D	-
- Development of the 32 point groups	
- Laue Groups	
3D Bravais Lattices	2
- Addition of a third translation to the plane groups	
- Derivation of Bravais Lattices	
3D Space Groups	4
- Screw Axes: combination of lattice translation and rotation	
- Development of the 230 space groups	
- Understanding the Space Groups entries in the International Tables of	
Crystallography	_
Quasi-crystals	1
Tensors and Physical Properties	3
- Definition of a tensor, rank of tensor	
- Transformation laws for tensors	
Why Transformation? Axis transformations, Orthoganlity conditions, Eulerian	
angles, Transofrmation operators for the crysllographic symmetry elements	
followed by 32 crystal classes	
- Tensor description of physical properties of crystals	
- Polar Tensor and Axial Tensor properties Effect of symmetry on grystal properties	
Effect of symmetry on crystal propertiesNeumann's Principal	
- Analytical form of Neumann's principle	
marytical form of freumann's principle	1

Pyroelectricity (First rank property tensors) - Pyroelectric Tensors - Symmetry Limitations Derivation of the symmetry point groups showing pyroelectricity - Polar Axes and Geometric representation Dielectric Constant (Second rank property tensors) - Origin of Dielectric constant - Dielectric tensor - Effect of symmetry	
Derivation of the symmetry point groups showing pyroelectricity - Polar Axes and Geometric representation Dielectric Constant (Second rank property tensors) - Origin of Dielectric constant - Dielectric tensor - Effect of symmetry	
- Polar Axes and Geometric representation Dielectric Constant (Second rank property tensors) - Origin of Dielectric constant - Dielectric tensor - Effect of symmetry	
Dielectric Constant (Second rank property tensors) - Origin of Dielectric constant - Dielectric tensor - Effect of symmetry	
 Origin of Dielectric constant Dielectric tensor Effect of symmetry 	
 Origin of Dielectric constant Dielectric tensor Effect of symmetry 	
- Dielectric tensor - Effect of symmetry	
- Effect of symmetry	
Neumann's law	
- Geometric representation	
Stress and strain (Second rank tensors)	
- Mechanical Stress	
- Stress transformation	
- Strain tensor	
- Matrix transformation for strain	
Piezoelectricity (Third rank property tensors) 3	
- Direct and Converse Piezoelectric Effect	
- Piezoelectric Modulus Tensor: a third rank tensor	
- Tensor and Matrix formulations	
- Matrix transformation and Neumann's Law	
- Reduction in the number of independent modulii: effect of crystal	
symmetry	
- Example: piezoelectric properties of quartz	
Elasticity (Fourth rank property tensors)	
- Thermal expansion of crystals	
- Generalized Hooke's Law	
- Stiffness and Compliance Tensors (fourth rank): inherent symmetry	
- Tensor and Matrix coefficients	
- Tensor and Matrix transformations	
- Effect of crystal symmetry	
Generalized approach to other symmetry dependent tensor properties 2	
- Optical properties, conductivity, ferroelectricity, etc.	
Total Lectures 40)

MSE 694N

Nanostructures and Nanomaterials: Characterization and Properties

Course structure and credits : 3-0-0-4 Prerequisite : Consent of Instructor

Objectives

At the end of the course the student should be able to:

- Have an overview of Nanomaterials, their structure and characterization techniques.
- Have an understanding of the properties of nanomaterials arising from size effect.
- Relating the biological-, ionic/electronic-, optical-, magnetic-, and mechanical-properties of nanomaterials with their structure and performance

References

- 1. Nanomaterials, Nanotechnologies and Design: an Introduction to Engineers and Architects, D. Michael Ashby, Paulo Ferreira, Daniel L. Schodek, Butterworth-Heinemann, 2009.
- 2. Handbook of Nanophase and Nanostructured Materials (in four volumes), Eds: Z.L. Wang, Y. Liu, Z. Zhang, Kluwer Academic/Plenum Publishers, 2003.
- 3. Encyclopedia of Nanoscience and Nanotechnology, Ed.: Hari Singh Nalwa, American Scientific Publishers, 2004.
- 4. Handbook of Nanoceramics and their Based Nanodevices (Vol. 2) Edited by Tseung-Yuen Tseng and Hari Singh Nalwa, American Scientific Publishers.
- 5. Introduction to Nanoscience, G.L. Hornyak, J. Dutta, H.F. Tibbals, A.K. Rao, CRC Press (2008).

Lecture Outline for MSE 694 N: Nanostructures and Nanomaterials: Characterization and Properties

Торіс	Lectures
Overview of Nanostructures and Nanomaterials: classification (Dimensionality, Morphology/ shape/structure of nano-entities, New Effect/ Phenomena). Crystalline nanomaterials and defects therein. Hybrid nanomaterials. Effect of size, structure, mechanism, and property on material performance	5
Multiscale hierarchical structures built out of nanosized building blocks (nano to macro). Eucledian, Hyperbolic and Spherical space structures. Nanostructures: Carbon Nanotubes, Fullerenes, Nanowires, Graphene, Quantum Dots.	3
Thermodynamics of Nanomaterials. Configurational entropy and Gibbs free energy of nanocrystals. Wulff reconstruction. Surface reconstruction and reconfiguration. Adsorption and Absorption.	5
Surfaces and interfaces in nanostructures. Solid/Liquid/Vapour interfaces. Grain boundaries in Nanocrystalline materials, Defects associated with interfaces. Overview of characterization of nanostructures and nanomaterials.	4
Nano-biomaterials: Self assembly of nanomaterials, DNA construct, hydrophobic surfaces, biomimicking, Case studies: Lotus leaf, Gecko feet, Nacre/Bone. Application of nanocomposite biomaterials: artificial biomaterials, antidrag coatings, self-cleaning surfaces, sensors, RNA molecules: Riboswitches	6
Nano-ionics/electronics and nanophotonics: Size quantization effect: Electronic state transition from bulk metal/ semiconductor to small cluster to single molecule. Quantum transport of electrons, Electrical conductance through a single atom, nanowire, nanotubes, Molecular scale electronics: Single molecule transistor. Surface plasmons, Transparent ceramics, transparent conducting oxides. Catalytic activity of nanomaterials: Electro-catalysis in fuel cell	8
Nanomagnetic: Magnetic properties of small magnetic clusters, nanoparticles, Ferrofluid Magnetoelectronics, Spintronics: Tunneling magnetoresistance, Giant magnetoresistance. Superparamagnetism: Magnetism relaxation, Effect of interparticle interaction, surface effects.	4
Nanomechanical: Inverse Hall Petch, Nanoindentation/ Nanoscratching, Deformation Behaviour of Nanomaterials, Effect of length scale, Grain boundary and thermal creep, Tribology	6
TOTAL	41

MSE 639

Interfaces and Materials Properties

Course structure and Credits: 3-0-0-4

Prerequisite: Consent of Instructor

Course Outline:

Surfaces and interfaces play extremely important role in determining the physical properties

of materials. These become of critical important especially when materials approach

nanoscale dimensions such as in the form of thin films and nanostructures. The objective of

this course is to provide the UG/PG students of MSE department a background on the

nature of various interfaces (Solid-Vapour, Solid- Liquid and Solid-Solid), their

thermodynamics, their interactions, nature of defect surfaces and domains. Special emphasis

will be paid towards understanding of the homophase (e.g. grain boundaries) and

heterophase systems (e.g. epitaxial films). As part of case studies, the contents will

elucidate a few metal and ceramic interface systems vis-à-vis their impact on the

functional properties. Finally, the students will be exposed to the surface modification

techniques that affect these interfaces and their functionality.

References:

1) Interfaces in Materials: Atomic Structure, Thermodynamics and Kinetics of Solid-Vapor,

Solid-Liquid and Solid-Solid Interfaces, James M. Howe, Wiley-Interscience

2) Physics and chemistry of interfaces By Hans-Jürgen Butt, Karlheinz Graf, Michael Kappl,

Wiley-VCH

3) Physics of surfaces and interfaces, H. Ibach, Springer.

4) Solid surfaces, interfaces and thin films, Hans Lüth, Springer.

5) Physical Chemistry of Surfaces, Arthur W. Adamson, Wiley-Interscience

10

Lecture Outline

Topic	#Lec
1) Introduction to the interfaces: basic classification and definitions	1
2) Basics of Energetics	4
Definitions and relations to physical properties	
Broken bond model	
Gamma plot	
Wulff plot and construction	
3) Solid-Vapour interfaces	6
Surface structure (Terraces, ledges and kinks) and defects	
Surface relaxation and reconstruction	
 Phase transformations 	
 Crystal growth from vapour (Nucleation and Growth, Vicinal surfaces) 	
Surface films	
4) Solid-Liquid Interfaces	6
Structure and properties of liquids	
 Interfacial structure and energy 	
 Crystal growth 	
 Solute partitioning and morphological stability 	
 Electrical aspects of surfaces and surface chemistry such as electrical double layer, 	
zeta potential	
5) Solid-Solid Interfaces	10
a) Types of solid-solid interfaces and basics	
b) Home-phase Interfaces	
 Grain boundary structure and energy 	
 Types of grain boundaries and dislocation models 	
 Stacking Fault and Twin Boundaries 	
Grain Boundary Segregation	
 Grain boundary and twin boundary equilibria 	
Domains in ferroelectric and ferromagnetic systems: energetic	
c) Hetero-phase Interfaces	
 Interphase boundaries 	

Tota	I	40
7) \$	Surface modification and impact on properties	3
•	 Interfaces in optical devices with emphasis on the solar cells and displays 	
	film devices	
•	• Interface effects on the magnetic properties of bulk magnetic materials and thin	
	behavior	
	o Heterostructures, strain and epitaxy and their effects on functional	
	thin films and heterostructures, domains and grainboundaries	
	 Interfaces effects in dielectrics, ferroelectrics and piezoelectrics and their 	
	Role of interfaces in conduction in metals and ceramics	
	Electrical Properties	
	Friction and adhesion	
	embrittlement, failure of ceramics and interface strengthening	
	 Grain boundary engineering, sliding and migration Fracture of metals and alloys: surface embrittlement, grain boundary 	
	 Effect on the strength of materials High temperature behaviour: Creep 	
•	Effect of interfaces in mechanical properties Effect on the strength of materials	
6) I	Interfaces and Functional Behaviour: Case Studies	10
6 \ 1	Growth, morphology and segregation at the heterophase interfaces	10
	Terrace-ledge and kink models	
	Interfaces between differences materials and structures	
	Antiphase Boundaries	
	Roughening and Phase transformations on interphase boundaries	
	Coherent and semcoherent interphase boundaries and their energetic	

MSE676 Materials Failure: Analysis and Prevention

Course structure and credits: 3-0-0-4 Prerequisite: Consent of Instructor

Course Objective: Materials failure has to be understood through a systematic analysis so that the weak link in the design-fabrication-performance chain can be identified and efforts in control/prevention of failures can be implemented. Failure analysis has grown over the year by trying to answer basic questions like: Why materials failure occurs? Can we predict failures? How best one can prevent common failures? etc.

Failure analysis is a fascinating subject as probing failures calls for application of a wide range of ideas and techniques in 'Materials Science and Engineering'. This course intends to be a 'Primer' to an highly applied field involving many technical concept and sophisticated experimental techniques. Many illustrative and interesting cases studies will be considered to give a comprehensive feel about the topic.

Lecture Outline

TOPICS	Lectures
Engineering Aspects of Failure and Failure Analysis General Practice in failure Analysis: Categories of failure, Importance of failure prevention	2
Tools and techniques in failure analysis: General Practices, Photography, X-rays techniques, Mechnical property evaluations, Metallographic techniques, Fractography, Non-destructuive testing technique	6
Failure mechanisms and modes: Fracture modes, Ductile fracture of metallic materials and their interpretations, factors affecting ductile-brittle relationships. (2 Lectures) Brittle fracture in normally ductile metallic alloy, microstructural aspects of brittle fracture (1 Lectures) Failure characteristics of Ceramics and Plastics (2 Lectures) Fatigue fracture, macroscopic and microscopic characteristics, statistical aspects of fatigue, Fatigue failure prediction and life assessments (2 Lectures) Wear Failures and Prevention. (2 Lectures) Corrosion related failures, Stress corrosion cracking, Hydrogen damage and embrittlement, Biological corrosion failures. (2 L) Elevated temperature failures, creep and stress rupture, metallurgical instabilities (2 L) Distortion failures and deformations (1 Lectures)	12
Examples of engineering failure Improper processing practice: Casting, metal working, welding, etc., Improper heat treatment: Gears, locomotive axle, shafts, etc. Improper design:Tools and dies, integrated circuits etc. Unanticipated service conditions: lifting equipment, reactors, etc. Improper material selection: Orthopedic implants, pressure vessels etc. Improper service condition: Pipelines, mechanical fasteners etc. Comprehensive failure analysis illustration	12 6
At least two cases based on aircraft crash, ship sinking, boiler blast, space mission failure, industrial catastrophe etc. (6 hours)	, and the second
Total Lectures	40

Reference books:

- 1. Source book in failure analysis, American Society of Metals, Metals Park, Ohio, 1974.
- 2. Understanding how components fail, D.J Wulpi, ASM International, The Materials Information Society, 1999.
- 3. A.J. McEvily, Metal Failures: Mechanisms, Analysis, Prevention, John Wiley and Sons, 2002.
- 4. Practical engineering failure analysis, H.M. Tawancy, A. Ul-Hamid and N.M. Abbas, Marcel Dekker, New York, 2004.
- 5. Failure analysis and prevention, Volume 11, ASM Handbook, The Materials Information Society, 2002.
- 6. Failure analysis of engineering structures: Methodology and case histories, V. Ramachandran, A.C. Raghuram, R.V. Krishnan and S.K. Bhaumik, ASM International, 2005.
- 7. Failure analysis of Engineering Materials, Charles R. Brooks and Ashok Choudhury.

MSE642 Microscopy and Microanalysis of Materials

Course structure and Credits: 3-0-0-4 Prerequisite of the course: Consent of Instructor

Objectives

At the end of the course the student should be able to attain the following objectives.

- 1. An exposure to a range of the basic characterisation techniques in the study of materials.
- 2. Good appreciation of the experimental data acquisition, interpretation, documentation and presentation.
- 3. An over all idea of the appropriate technique to adopt for a characterisation problem on hand.
- 4. One should a able to easy appreciate and understand research publication and presentation related to the techniques discussed.

Suggested Text/reference books:

- 1. Fundamental of light microscopy and electronic imaging, D.B. Murphy, Wiley-Liss, 2001
- 2. Microstructural Characterization of Materials D. Brandon and W.D. Kaplan, John Wiley and Sons, 2008
- 3. Scanning Electron Microscopy & X-Ray Microanalysis, J.Goldstein et.al, Springer, 2003
- 4. Transmission Electron Microscopy B.D. Williams & C.B. Carter, Springer, 2009
- 5. Science of Microscopy, P.W. Hawkes and J.C.H. Spence, Springer, 2007
- 6. Surface Analysis methods in materials science, Editors: D.J.O'Connor, B.A. Sextton, R.St. C. Smart, Springer, 2003.
- 7. Materials Characterisation Techniques, S. Zhang, Lin Li and Ashok Kumar, CRC Press, 2009
- 8. Fundamentals of Materials Science-the microstructure-property relationship using metals as model systems, E.J. Mittemeijer, Springer, 2010

Lecture Outline

1	Advanced Optical microscopy	4
	 Special microscopy techniques and applications: Bright field and dark field imaging; confocal microscopy; interference microscopy; polarized light microscopy; phase contrast microscopy. Scanning near field laser microscopy Image processing and quantification 	
2	Scanning electron microscope	8
	 Basis of image contrast and various operating modes in SEM SE and BSE, X-ray, EBIC, cathodoluminescence, voltage contrast mode, Magnetic contrast tmode. (2) Environmental SEM, Low voltage SEM, and applications (1) Electron back scattered diffraction /OIM: Basic principles, the micro-textural data acquisition and analysis, applications (3) Fractography and failure analysis (2) 	
3	Transmission electron microscope	14
	 Wave properties of electrons, lens defects, aberration corrected TEM and sub-Angstrom resolution (2L) Origin of contrast: mass-thickness contrast, diffraction contrast and crystal defect analysis. Dynamic diffraction and anomalous absorption effects, image artifacts (3L) BF, DF, Weak beam DF images and applications (1L) Electron Diffraction: SADP, Micro-diffraction, CBED. Diffuse scattering and fine-structure in Diffraction pattern. (2L) Phase contrast and HRTEM: Contrast transfer function and lattice imaging, Computer simulation of lattice and structural images, Interpretation of images and illustrative examples(2L) STEM-HAADF imaging, information limit (1L) Lorentz microscopy and holography (1) Specimen preparation: Mechanical thinning, electrochemical thinning, ion milling, sputter coating and carbon coating, replica methods (2L) 	
4	Microanalysis in SEM and TEM	5
	 X-ray microanalysis: EDS and WDS: Basic principles and analysis modes (1L) Quantitative analysis and elemental mapping (1L) Comparisons: EDS vs WDS, quantification in SEM/EPMA vs AEM (1L) Electron Energy Loss spectroscopy: Limits of detection and resolution (1L) Typical applications in materials analysis (1) 	
5	Surface Imaging and microanalysis	10

- Rutherford back scattering(RBS): principles and applications (1L)
- Scanning Tunneling Microscopy (1L)
- Atom Force Microscopy (AFM) and different operational mode and typical applications (2)
- Focus ion beams (FIB) and TEM sample preparation (1)
- X-ray Photoelectron Spectroscopy(XPS): Basic principles and typical application
- Auger Electron Spectroscopy (AES): Principle, instrumentation and applications (2)
- Dynamic SIMS and static SIMS, principles and applications (2)

Total 40

MSE 658 Dislocations and Plasticity

Course structure and credits: 3-0-0 -4 Prerequisite: Consent of Instructor

Objectives

At the end of the course the student should be able to:

- Have a broad understanding of defects in materials and their role in determining properties of materials.
- Have an overview of plastic deformation mechanisms and the role of dislocations in plasticity, fracture, fatigue and creep.
- Have a thorough understanding of the structure of dislocations in various crystals and their elastic fields.

References

- 6. Introduction to Dislocations, D. Hull and D.J. Bacon, Pergamon Press, Oxford, 1984.
- 7. Theory of Dislocations, J. P. Hirth and J. Lothe, McGraw-Hill, New York, 1968.
- 8. Crystal Defects and Crystalline Interfaces, W. Bollmann, Springer-Verlag, Berlin, 1970
- 9. Elementary Dislocation Theory, J. Weertman and J. Weertman, The MacMillian Company, New York, 1964.
- 10. http://www.tf.uni-kiel.de/matwis/amat/def_en/

Lecture Outline

Topic	Lectures
Overview of defects in Materials	1
- (point, line, planar and volume defects) and their classification.	
- Overview of plastic deformation mechanisms	
Point defects:	4
- interaction and distributions	
- statistical thermodynamics	
- role in diffusion and deformation.	
Basic understanding of dislocations using physical and computer models:	4
- the Volterra cut	
- Burgers vector and the Burgers circuit	
- the line vector	
- edge, screw and mixed dislocations	
- Role of dislocations in weakening the crystal and in plasticity.	
Elasticity theory of dislocations:	3
- Stress, strain and displacement fields and energy of a dislocation	
- Forces on dislocations (including image force)	
- Interaction between dislocations	
- Core of a dislocation.	
Motion of dislocations:	5
- The Peierls stress	
- role of the core structure	
 interaction of dislocations with other defects (including yield point phenomenon); 	
- kinks; jogs; cross-slip; climb	
- Temperature and strain-rate dependence of flow stress	
- Dislocation dynamics and the tensile stress-strain curve.	
Dislocations in FCC Metals:	4
- Partial dislocations (Shockley and Frank partials)	
- stacking faults	
- Thompson's tetrahedron	

-	Lomer-Cotrell sessile dislocation			
Overvi	Overview of dislocations in other crystal structures:			
-	HCP metals			
-	BCC metals			
-	ionic crystals			
-	superlattices			
-	covalent crystals.			
Origin	and multiplication of dislocations:	4		
-	dislocations in freshly grown crystals			
-	nucleation of dislocations			
-	multiplication of dislocations (by Frank-Read sources, cross slip and climb)			
-	Grain boundary sources			
-	Recovery and recrystallization.			
Geom	etrically/structurally necessary dislocations:	5		
-	low-angle & general grain boundaries			
-	indentation			
-	interfacial dislocations			
-	Twinning including incoherent twins.			
Specifi	c examples of role of dislocations and case studies:	8		
-	Dislocations in nanocrystals			
-	The Hall-Petch relation and the Inverse Hall-Petch Effect (IHPE)			
-	Dislocations in epitaxial systems			
-	Severe Plastic deformation			
-	Role of dislocations in Creep, Fatigue and Fracture			
	TOTAL	40		

Stream: Metals Processing

Sl. No.	Course Title	
1	MSE421 Iron and Steel Making	
2	MSE 422 Selection and Design of Engineering Materials	nis UG courses details ot given in this ment
3	MSE 651A Advanced Concepts in Ironmaking	
4	MSE 670 N Solidification Processing and Joining	
5	MSE 657 Deformation Processing	
6	MSE 659 Powder Metallurgy	
7	MSE 671 Heat-Treatment and Surface Hardening	

Course No: MSE 421

Course Name: Iron and Steel Making

Credits: 3-0-0-0-4 **Prerequisite:** None

Category:

Elective course for undergraduate students of MSE department, to be offered in even semester.

Course Outline (Total number of lectures planed = 41)

Introduction (1 Lecture hour)	Lecture hours
General introduction to the subject: Historical	
perspective; Importance and role of iron and	1
steel in human civilization; Integrated iron and	
steel plants; Iron and steel production in India	
Review of Thermodynamics and Kinetics Prin	nciples (6 Lecture hours) Lecture hours
Thermodynamics: First law and energy	
balance; Basic concepts of chemical	
equilibrium; Ellingham diagrams; Behaviour of	
solutions- Raoult's law and Henry's law,	4
Thermodynamic activity of a component in a	
solution, Alternative standard states, Dilute	
solutions and interaction parameters.	
Chemical kinetics: Definition of reaction rate;	1
Factors affecting the rate of reactions; Kinetics	
of homogeneous and heterogenous reactions.	
Mass transfer: Diffusive and convective fluxes;	1
Fick's laws of diffusion; Mass transfer co-	
efficient; Some examples of mass-transfer in	
metallurgical applications	
Ironmaking (15 Lecture hours)	Lecture hours
Blast furnace (BF) ironmaking: Construction,	
features and design of modern-day BF; BF	
accessories; Raw materials and burden	
preparation (coke making, sintering and	6
pelletizing); Physical, chemical and thermal	
processes in a BF; BF operations; BF products	
and hot metal quality	
Blast furnace (BF) ironmaking: Principles of	6
material and energy balances- material	
balances, energy(enthalpy) balances, chemical	
and thermal reserve zones	
Modern developments in BF operations: Large	2
BFs, improved charging systems and burden	
distributions, high top pressure, auxiliary fuel	
injection	

Miscellaneous topics: Alternative ironmaking;	1
Pre-treatment of hot metal etc.	
Steelmaking (16 Lecture hours)	Lecture hours
Principles of steelmaking: Thermodynamics	4
and kinetics of steelmaking reactions	
Historical perspectives and development of the	1
basic oxygen steelmaking (BOS) processes	
Basic oxygen steelmaking (BOS) processes:	2
Features of BOS, accessories, physio-chemical	
processes in BOS, bottom blown and combined	
blowing steelmaking processes	
Electric arc furnace (EAF) steelmaking: Main	3
features of EAF, steelmaking in EAF including	
stainless steelmaking	
Deoxidation practices and inclusions in steel	1
Secondary steelmaking: Ladle and tundish	3
metallurgy operations-teeming, inert gas	
stirring, vacuum degassing, LF, powder	
injection etc.	
Casting of steel: Introduction about casting	2
processes-solidification, ingot casting and	
continuous casting	
Integrated Topics (3 Lecture hours)	Lecture hours
Refractories in ironmaking and steelmaking	1
Emerging trends in ironmaking and	1
steelmaking	
Ironmaking and Steelmaking in India	1

TEXT AND REFERENCE BOOKS:

- $1.\,A$ First Course in Iron and Steelmaking: by D. Mazumdar, University Press, Hyderabad, 2015
- 2. Ironmaking and Steelmaking: Theory and Practice: A. Ghosh and Amit Chatterjee, Prentice Hall India.

MSE 651A

Advanced Concepts in Ironmaking

Course Structure and Credits: 3-0-0-0 [9 credits]

Prerequisite: Exposure to undergraduate courses on Ironmaking and Thermodynamics of Materials

Course Outline

The course is designed for advanced UG, and PG students interested in the theory of blast furnace (BF) ironmaking and alternative ironmaking technologies. The course begins with a review of the basic concepts of thermodynamics, chemical kinetics and mass transfer, and slag theory. Thereafter, it discusses about the reactions taking place in a BF and goes on to develop a 0-D model for the BF by combining stoichiometry and enthalpy balances for the upper and lower parts of the furnace. The 0-D model is then validated using different tests and the effects of several process variables on a BF operation are elucidated using the model. After the discussion on BF ironmaking, advanced concepts in some of the alternative ironmaking technologies are covered, with emphases on those technologies which are particularly relevant in the Indian perspective.

Course Contents

Sr. No	Broad Title	Topics	Lectures
1.	Introduction	An overview of the course contents and a general introduction to BF ironmaking	1.0
	Thermodynamics: First law and energy balance, Basic concepts of chemical equilibrium; Behavio of solutions- Raoult's law and Henry's law, Alternative standard states, and Interaction parameters.		2.0
2.	Review of Fundamentals	Chemical kinetics and Mass transfer: Kinetics of homogeneous and heterogenous reactions; Diffusive and convective fluxes; Fick's laws of diffusion	1.0
		Structure of slags; Physicochemical properties; Molecular and ionic models for calculating activities in slag	1.0
3.	Agglomeration of Iron Ores-I	Sintering: Fundamentals; Sintering zones; Temperature profile and heat input; Sinter phases and mechanisms; Reaction sequences; Effects of mineralogical composition on sinter quality	2.0
4.	Agglomeration of Iron Ores-II	Pelletization; Fundamentals; Green Pelletization; Induration of pellets- physico-chemical changes and underlying mechanisms; cooling of indured pellets; Fluxing of pellets- effects of mineralogical composition on reducibility of pellets	
5.	Blast furnace reactions	Physical chemistry of BF reactions: Combustion of coke in the tuyere zone; Equilibria between gases	3.0

		and solids in the BF stack; Kinetics of BF reactions in the stack-kinetics of reduction of iron oxides and kinetics of carbon gasification; BF reactions occurring in bosh and hearth	
6.	Blast furnace stoichiometry	Stoichiometric development: Elemental and Material Balances; The Stoichiometric Equation; Graphical Representation	2.0
		Simplified enthalpy balance: Assumptions; The enthalpy balance; Heat supply and heat demand; General enthalpy framework; Examples.	1.0
7.	Development of BF model framework	Combination of stoichiometric and enthalpy equations; Graphical representation of combined stoichiometric-enthalpy equation; Summary and discussion on the stoichiometry/enthalpy graph	1.5
8.	Completion of the stoichiometric part of the BF model	Division of BF as two separate reactors; Stoichiometric balances for bottom segment; Stoichiometric equation for wustite reduction zone; Discussions	1.0
9.	Enthalpy balance for bottom segment of a BF	Enthalpy balance for the bottom segment of the BF; Demand-supply form of the enthalpy equation; Numerical development	2.0
10.	Combining stoichiometry and enthalpy equation for the bottom segment	Implications of the equations-Effects of an increased heat demand and blast temperature; Graphical representation; Characteristics of operating line-effects of bottom segment heat demand on carbon and oxygen requirements, effects of blast enthalpy	2.0
11.	Testing of mathematical model	Testing for thermal validity; Calculation of top-gas temperature; Testing for stoichiometric and thermodynamic validity; Validity of model assumptions; Temperature effects in Thermal Reserve Zone	2.0
12.	Effect of tuyere injectants on BF operation	Representing injected materials in the bottom segment stoichiometric and enthalpy equations; Example calculations- Oxygen enrichment, Hydrocarbon injection; Graphical calculations for a general injectant; Top-gas composition with hydrogen injection; Discussions	3.0
13.	Addition of details into the operating equations for a BF	Stoichiometric effects-Reduction of SiO ₂ and MnO, Effects of CaCO ₃ decomposition on carbon and oxygen balances, Decomposition of other carbonates; Enthalpy effects- Radiation losses, Reduction of SiO ₂ and MnO; Decomposition of limestone, Slag heat demand	3.0
14.	Summary on BF ironmaking	Summary of model development steps; Comparison of model predictions with BF data, Effects of various operating parameters on BF operation-prediction and practice	1.0
14.	Alternative Ironmaking-I	Introduction to alternative ironmaking technologies-Classification; Coal based DRI production- Rotary kiln technology: Basic principle; Preheat zone and Reduction zone; Mass and heat balance calculations; Major reactions in a	3.0

References:

- 1. The Iron Blast Furnace, J.G.Peacey and W.G. Davenport, Pergamon Press, 1979
- 2. Ironmaking and Steelmaking-Theory and Practice, A. Ghosh, and A. Chatterjee Prentice Hall India, 2011
- 3. A First Course in Iron and Steelmaking, D. Mazumdar, Universities Press, 2015
- 4. Related papers on Rotary Kiln, Midrex and Corex technologies (to be distributed in class)

MSE 670N Solidification Processing and Joining

Course structure and credits: 3-0-0-0 [9 credits]
Prerequisite: None

Course Content:

Thermodynamics of solidification, Nucleation and growth, Pure metal solidification, Gibbs-Thomson effect, Alloy Solidification: Mathematical Analysis of redistribution of solute during solidification, Constitutional undercooling, Mullins-Sekerka instability, Dendritic growth, Multiphase solidification: eutectic and peritectic, Structure of casting and ingots, Types of casting, Heat transfer, Design of riser and gating, Joining, different joining processes, Fusion welding, Solidification, heat transfer, fluid flow during

fusion welding, Modelling of solidification under different conditions

Books Recommended:

- 1. Solidification Processing; Fleming, M.C., McGraw-Hill, N.Y., 1974
- 2. Solidification of Casting; Ruddle, R.W., Institute of Metals, 1957
- 3. Solidification and Casting, Davies, G.J., John Wiley and Sons, 1973
- 4. Science and Engineering of Casting Solidification; Stefanescu, D.M., Kluwar Publications, 2002
- 5. Fundamentals of Solidification by Kurz, W. and Fisher, D.J., Trans-Tech Publications, Switzerland, 1989
- 6. Applied Welding Engineering: Process, Codes and Standard; R.Singh,. Elsevier Inc., 2012

Lecture wise distribution of various topics:

Sl.No	Торіс	No of lectures
1	Introduction to the course: Relevance of solidification	1
	natural and industrial processes and welding	
2	Thermodynamics of solidification:	2
	-Thermodynamics of undercooled melts, Driving force for	
	solidification	
	- Free energy formulation for metastable phase formation	
3	Nucleation and Growth:	6
	-Theory of homogeneous nucleation,	
	-Concept of solid-liquid interfacial energy, Theory of	
	heterogeneous nucleation;	
	-Interface kinetics, growth mechanisms: continuous growth, step	
	wise growth	
4	Pure metal solidification:	2
	-Undercoolings,	
	-Gibbs-Thomson effect	_
5	Alloy solidification:	6
	- Solutal undercooling	
	-Mathematical analysis of redistribution of solutes,	
	- Constitutional undercooling,	
	- Mullins-Sekerka instability	
6	Single alloy phase solidification:	6
	-Cellular and Dendritic growth: Cell formation; cell to dendrite	
	transition;	
	-Free dendritic growth, instability of a growing spherical nucleus,	
	-Propagation of dendrite main stem, marginal stability,	
7	-Marginal stability	6
7	Multiphase solidification: - Eutectic growth, classification, eutectic range	0
	-Peritectic growth: aligned peritectic growth	
8	Structure of casting and ingots:	3
	-Types of casting, Heat transfer	3
	- Ingot structure: chill zone, columnar zone, equiaxed zone,	
	continuous casting	
9	Design of riser and gating:	2
	-Gating, Fluidity, Risering pure materials	2
10	Welding	4
10	-solidification during welding, different types of fusion welding	
	processes,	
	-solid state welding: friction welding, friction stir welding	
11	Nucleation and growth of phases during welding	1
12	Heat transfer, fluid flow, and solute distribution during welding	2
13	Mathematical modeling of solidification	2
1.5	- Phase field modeling	_
	- Solidification during welding	
	T	1

Total lectures planned=41

INDIAN INSTITUTE OF TECHNOLOGY KANPUR DEPARTMENT OF MATERIALS SCIENCE AND ENGINEERING

MSE657 Deformation Processing

Course structure and Credits: 3-0-0-0 [9 credits]
Prerequisite: None

Course Content:

Slip planes and systems in various crystal systems; Elasticity and Plasticity; Deformation processes including Rolling ;Forging, Extrusion; Drawing and deep drawing etc.; Deformation of plastics and polymers; superplasticity; Formability; Failures; Friction wear and lubrication

Recommended text books:

- 1. Hosford, W. F., and Cadell, R. M., 2007, *Metal Forming: Mechanics and Metallurgy*, Cambride University Press, Cambridge.
- 2. George Dieter, 1986, Mechanical Metallurgy, Mc-Graw Hill

Other Sources:

1. http://www.doitpoms.ac.uk/tlplib/metal-forming-2/index.php

Lecture wise distribution of various topics:

Sl.No.		TOPICS	Number of Lectures
1	Introduction	Importance of deformation processes to Industrial Manufacturing	1
2		Slip planes and systems in various crystal systems	1
	Franklansantala	Elasticity and Plasticity	2
	Fundamentals	Texture and its effect	2
		Effect of Temperature (Grain Refinement and Growth)	2
3		Rolling	3
		Forging	2
		Extrusion	3
	D	Drawing (Wire, Rods, Tube)	3
	Processes	Sheet Metal Forming	3
		Deep Drawing	2
		Machining	3
		Deep Drawing and Stamping	1
4	Deformation of Plastics	Deformation processes for plastics and polymers	2
5		Introduction	1
	Superplasticity	Theory of superplasticity and Material Design	2
		Applications	2
6	Failure, Formability,	Failures, Formability and the Formability Limit Diagrams	3
	Friction, Lubrication and Wear	Friction, Wear and Lubrication	2

Total lectures planned:40

Powder Metallurgy MSE 659

Course structure and credits : 3-0-0-0 [9 credits]
Prerequisite : TA201 (MSE)

Course Content:

Powder Production (Chemical Methods, Electrolytic Methods, Atomization, Mechanical Methods), Powder Characterization (Chemical Composition and Structure, Particle Size and Surface Topography, Pyrophorocity and Toxicity), Powder Compaction, Phenomenological Aspects of Sintering, Solid-State Sintering, Analytical Approach to Sintering, Non-Isothermal Sintering, Microstructural Evolution, Liquid Phase Sintering, Stages of Liquid Phase Sintering, Supersolidus Sintering, Activated Sintering, Pressure- Assisted Sintering, Microwave Sintering, Select Case Studies.

Books Recommended:

- 1. R.M. German, Powder Metallugy Science, 2nd ed. John Wiley, 1999.
- 2. A. Upadhyaya, G.S. Upadhyaya, Powder Metallurgy: Science, Technology and Materials, 2011.
- 3. ASM Handbook, Volume 7: Powder Mtal Technologies & Applications (1998)

Lecture wise distribution of various topics

Sl.No.	Topics	Lectures
1	Introduction	3
	1.1 Powder Production and Characterization	
	1.2 Powder Compaction	
	1.3 Sintering	
	1.4 Full Density Processing	
	1.5 Secondary Treatments	
	1.6 Applications	
2.	Powder Production	5
	2.1 Chemical Methods	
	Solid-state reduction; hydrometallurgical reduction; ion	
	Exchange method, direct synthesis.	
	2.2. Electrolytic Methods	
	2.3 Atomization Method	
	2.3.1. Solidification and Microstructural Evolution	
	2.3.2. Gas Atomization and Water Atomization	
	2.4 Evaporation Methods	
	2.5 Mechanical Methods	
	2.5.1. Basic Aspects	
	2.5.2. Particle Size Reduction Equipments	
3.	Powder Characterization	4
	3.1. Chemical Composition and Stucture	
	3.2. Particle Size and Surface Topography;	
	3.3. Pyrophorocity and Toxicity	
	3.4. Powder Production Methods and Characterization	
4.	Powder Treatment	2
	4.1. Annealing and Diffusion Alloying Al-Si MMCs	
	4.2. Granulation	
	4.3. Coating of Metal Powders	
5.	Powder Compaction	5
	5.1. Die Compaction	
	Pressing operation, press selection, factors affecting	
	tooling design, tooling materials	
	5.2. Warm Compaction	
	5.3. CIP and Roll Compaction	
	5.4. Powder Extrusion	
	5.5. Injection Molding	
6.	Pressureless Powder Shaping	4
".	6.1. Slurry Molding and Slip Casting	·
	6.2. Tape Casting	
	6.3. Electrophoretic Deposition	
	6.4. Spray Deformation	
	6.5. Solid-Preform Fabrication	
7.	Sintering Theory	8
/·	7.1. Solid-State Sintering (Pressureless)	
	7.1.1. Analytical Approach to Sintering	
	7.1.2. Non-Isothermal Sintering	
	7.1.2. 11011-150thermal Simering	

	7.1.3. Microstructural Evolution	
	7.1.4. Numerical Simulation of Sintering	
	7.1.5. Phenomenological Aspects of Sintering	
	7.1.6. Sintering Maps	
	7.1.6. Sintering Nano-Powders	
	7.2. Liquid Phase Sintering	
	7.2.1. Stages of Liquid Phase Sintering	
	7.2.2. Microstructural Evolution	
	7.2.3. Supersolidus Sintering	
	7.3. Activated Sintering	
	7.4 Pressure-Assisted Sintering	
	7.4.1. Plastic Yielding Mechanisms	
	7.4.2. Creep Mechanisms	
	7.4.3. Viscous Flow Mechanisms	
	7.5. Electronic Theory of Sintering	
	Basics; Liquid Phase Sintering, Activated Sintering	
	Case Study: Sintering of Refractory Carbides.	
8.	Sintering Technology	3
	8.1. Rapid Protyping Process	
	8.3. Sinter Hardening	
	8,2. Microwave Sintering	
9.	Select Case Studies	4

Total lectures planned: 38

MSE 671

Heat Treatment and Surface Hardening

Course structure and Credits: 3-0-0-0 [9 credits] Prerequisite: Phase Transformation for UG and None for PG

Course Content:

Introduction, Theory of Heat Treatment, Heat Treatment Environment, Different Heat Treatment Techniques, Fundamentals and Properties; Annealing, Tempering, Hardening, Thermomechanical treatment, Fundamentals of Surface Hardening Treatment, Carburizing, Carbonitriding, Nitriding, Modern surface hardening techniques; Economy of Heat Treatment Processes

.

Books Recommended:

- 1. Principles of Heat Treatment of Steels by R.C. Sharma
- 2. The Heat Treating Source Book, ASM, 1986
- 3. Heat Treatment of Metals by W.S. Owen (1963) (Institute for Metallurgists)
- 4. Engineering Physical Metallurgy and Heat Treatment by Y. Lakhtein (Mir Publisher)
- 5. Phase Transformations in Metals and Alloys by D.A. Porter and K.E. Easterling (Taylor and Francis)

Lecturewise distribution of various topics

Sl. No	TOPICS	No. of Lectures
1.	Introduction 1.1 Definition 1.2 Aim 1.3 Trends in Heat Treatment Technology	1
2.	Theory of Heat Treatment 2.1 Structure of Metals and Alloys and Materials 2.2 Phase diagram and phase transformation 2.3 Effect of Alloying 2.4 Fundamentals of TTT and CCT diagram 2.5 Microstructure and Properties as a function of Heat Treatment	12
3	Heat Treatment Environment 3.1 Vacuum 3.2. Furnace 3.2 Atmosphere	2
4	Different Heat Treatment Techniques, Fundamentals and Properties 4.1 Annealing 4.1.1 Full and partial annealing 4.1.2 Spheroidizing Anneal 4.1.3 Isothermal Anneal 4.1.4 Normalizing 4.2 Hardening and Quenching 4.2.1 Hardenability 4.2.2 Use of transformation diagram 4.2.3 Fundamentals of Martensite formation 4.3 Tempering 43.1 Tempering of martensite 4.4 Thermomechanical Treatments 4.4.1 Recrystallization and Grain growth 4.5 Heat Treatment of non-ferrous alloys (Al alloys, Ni-based super alloys) 4.5.1 Stages of precipitation and ageing 4.6 Heat Treatment of PM Products	16
5	Fundamentals of Surface Hardening Treatment 5.1 Carburizing 5.2 Nitriding 5.3 Carbonitriding 5.4 Induction and Flame Hardening 5.5 Laser and Electron Beam Heat Treatment	8
6	Economy of Heat Treatment Processes 6.1 How to design low cost effective and improved heat treatment processes	1

Total Lectures planned=40

Stream: Functional Materials

Sl. No.	Course Title
1	MSE604
	Science and Technology of
	Thin Films and Device Fabrication
2	MSE 624
	Energy Materials and
	Technologies
3	MSE 628
	Electronic Devices and
	Characterization
4	MSE 631
	Electroceramic Materials
	and Applications
	and Applications
5	MSE 693N
	Materials Science
	Technologies for Applications in Life
	Sciences

MSE604 Science and Technology of Thin Films and Device Fabrication

Course structure and Credits: 3-0-0-4 Prerequisite: Consent of Instructor

Objectives

To provide the essential basic knowledge related to thin films and device fabrication. Emphasis will be placed on various thin film technologies based on vacuum processes and chemical process followed by detailed discussion on device fabrication including aspects of photolithography, patterning, etching, heat treatment(s), and metallization by considering certain device cases.

Reference Books:

- VLSI Fabrication: S.K. Gandhi
- Si Processing (Volume I and II)
- · Lou and Mayer
- Introduction to Microfabrication by Sami Fransilla (Wiley)
- Fundamentals of Microfabrication: The Science of Miniaturization by Marc Madou (CRC Press)
- Thin film deposition by Donald Smith (Mc Graw Hill)
- Materials science of thin films by Milton Ohring (Academic Press)
- Pulsed Laser deposition of thin films by Chrisey and Hubler (Wiley Interscience)

SI. No.	TOPICS	# Lectures
1. Introduction	 Introduction to device processing steps Examples of various devices (with emphasis on solar cells and MOSFETs) Need for miniaturization 	4
Thin Film Deposition	,	1
2. Basics of thin film growth	 Brief review of kinetic theory Adsorption and desorption Film growth: nucleation and growth kinetics Epitaxy Thin film growth control 	3
3. PVD Processes	 Evaporation (Thermal and e-beam) Principles of glow discharge and various sputtering processes 	5
4. Chemical Growth Processes	 Fundamentals of CVD growth Modern variants: MOCVD, PECVD and ALD Spin Coating 	4
5. Basic Thin Film Characterization	 Thickness measurement Phase analysis Optical analysis Morphology analysis 	1
Device Fabrication	, ,	1
6. Substrate selection and preparation	 Selection of substrates Single crystal growth (Silicon) Role of substrate surface and contaminants Physical and chemical methods of substrate surface preparation 	3
7. Pattern fabrication	 Concepts of lithography Photoresists (Negative, Positive etc) Exposure Development Masking Variants of lithography with emphasis on Photo and ebeam Precautionary steps 	5
8. Material Removal	Wet (Chemical) and dry (Plasma, RIE etc.) etching	5
9. Ion implantation, Doping, oxidation and heat treatment	 Doping and Ion Implantation Diffusion control of composition in devices Oxidation and heat treatment 	6

10. Metallization and Interconnects	 Adhesion and morphology issues Introduction to electromigration vis-à-vis metallization: Impact on device performance and methods of prevention 	2
11. Process Integration for a particular case (take the case of a device)	Example of process integration for a particular kind of device e.g. Si Solar Cell, MOSFET, III-V solar cell devices	4
Total		42

MSE 624

Energy Materials and Technologies

Course structure and Credits : 3-0-0 -4
Prerequisite : Consent of Instructor

Objectives

To provide the fundamental knowledge for understanding concepts of different technologies based on electronic devices. Focus in this course will be on manufacturing techniques and materials selection.

Reference Books:

- 1. Handbook of Photovoltaics Science and Technology, By Antonio Luque and Steven Hegedus
- 2. Physics of Solar Cells, By Jenny Nelson
- 3. Physics of solar cells: from basic principles to advanced concepts, By Peter Würfel and Uli Würfel
- 4. Organic photovoltaics: materials, device physics, and manufacturing technologies, By Christoph J. Brabec, Vladimir Dyakonov, Ullrich Scherf
- 5. Principles of Solar Cells, LEDs and Diodes: The Role of the PN Junction, By Adrian Kitai
- 6. Electroceramics: materials, properties, applications by A.J. Moulson and J.M. Herbert
- 7. Electroceramics-based MEMS: fabrication-technology and applications, By Nava Setter

SI. No.	TOPICS	Number of Lectures
Introduction	Relevance of renewable energy generation, conservation and harvesting vis-à-vis environmental concerns (Energy requirement of society and depleting fossil fuels; Break-up of various renewable energy sources and consumption patterns)	1
Optoelectronic devices	Solar cell device physics LED device physics	4
Generation: Photovoltaic technologies	Solar energy: amount of energy available area wise; Available solar energy technologies (0.5) PV technologies, materials, processes and issues First generation technologies – Si based (2) Thin film (a-Si, CdTe, CIGS): 6 Solar concentrators (3) Third generation (high efficiency and low cost) – Organic and dye solar cells, multi-junction, quantum dots (5) Present Status and future outlook and Indian Scenario (0.5)	17
Energy Efficient Lighting	 a. Introduction, Energy efficient buildings, role of sensors etc (0.5) b. Comparison of LEDs with conventional technologies (0.5) c. Principles of light emission; Optical processes and materials d. Light Emitting Diodes (LEDs): Introduction to p-n junction, hetero-junctions, recombination processes, semiconductor materials (III-V, II-VI, SiC, ternary and quaternary alloys) for LEDs, metallurgical considerations (crystal defects, lattice mismatch, optical losses, degradation), and fabrication technology e. OLED for lighting f. Characterization 	10

Energy Conversion Devices	Description of Operation, Configurations, Cell Components, Materials Requirements, Manufacturing Techniques, Losses, Efficiency Solid Oxide Fuel Cells Solid Oxide Electrolyzer Cells Batteries Capacitors	5
Energy Harvesting Materials and Technologies	Working principles and case studies of with emphasis on materials, their selection vis-à-vis their characteristics: Piezoelectric Sensors, Actuators, Transducers and MEMS (3) Thermoelectrics (1) Applications: Ultrasound Imaging, Pyroelectric Sensors IR imaging (1)	5
Total		42

MSE628 Electronic Devices and Characterization

Course structure and Credits: 3-0-0-4 Prerequisite: MSE303 or equivalent

Objective:

To develop understanding of two important device structures that is, p-n diode and Metal-oxide- semiconductor field-effect transistor (MOSFET). Also, provide knowledge of various device characterization techniques that determine/control the functioning of devices.

References

- Semiconductor Material and Device Characterization, <u>Dieter K. Schroder</u>, January 2006,
 Wiley-IEEE Press
- (2) Metal-Semiconductor Contacts (Electrical & Electronic Engineering Monographs), E. H. Rhoderick and R. H. Williams, Oxford University Press, USA; 2 edition (September 1, 1988)
- (3) Electronic Structure of Metal-Semiconductor Contacts, Winfried Mönch (Nov 30, 1990)Springer; 1 edition (November 30, 1990)
- (4) Optical Techniques for Solid-State Materials Characterization, Rohit P. Prasankumar and Antoinette J. Taylor, CRC Press; 1 edition (July 5, 2011)
- (5) <u>Semiconductor Device Fundamentals</u> by Robert F. Pierret, Addison Wesley; 2nd edition (April 12, 1996)
- (6) <u>Advanced Semiconductor Fundamentals (2nd Edition)</u> by Robert F. Pierret, Prentice Hall; 2 edition (August 19, 2002)
- (7) Semiconductor Devices: Physics and Technology, <u>Simon M. Sze</u>, <u>Ming-Kwei Lee</u>, Wiley; 3 edition (May 15, 2012)

	Topic	Lec.
1.	Electronic Device related characteristics of a semiconductor material	
	Review: -n and -p type semiconductors, wafers, carrier mobility,	
	conductivity, equilibrium carrier statistics, generation-recombination	
	processes and carrier transport, traps and defect states (2)	
	Characterization	
	(a) Doping density: Secondary Ion Mass Spectroscopy (SIMS) (0.75)	5
	(b) Resistivity: Four-point probe (0.75)	
	(c) Charge carrier type, density, mobility: Hall effect (1)	
	(d) Band-gap: UV-Visible spectroscopy (0.75)	
	(e) Absorption coefficient (0.5)	
2	Semiconductor – semiconductor junction	
	<u> </u>	
	(a) P-N junction in thermal equilibrium, J-V characteristics:	10
	qualitative (3)	10
	(b) P-N junction's J-V characteristics of an ideal device, origin of non idealities (4)	
	idealities (4)	
	(c) Diode variants: solar cell (J-V with illumination and bias effect	
	and PIN diode, LEDs (2.5)	
	(d) Device measurement of a solar-cell (Light and dark J-V, R _s , R _{sh} ,	
	Efficiency) (0.5)	
	(e) BJTs: Principle and device measurement (2)	
3	Metal – Semiconductor junction	
	(a) Schottky and Ohmic contacts,	
	thermionic-emission, Tunnelling, Schottky diodes (2)	
	(b) Contact resistance: Two terminal; Four terminal technique (0. 5)	5
	(c) Barrier height: From I-V, C-V, Photo-current; comparison of three (1)	
	(d) Capacitance – Voltage measurements: Doping-Density and	
	majority carrier density profiling (1)	
	(e) Band-offset for a semiconductor – semiconductor junction using	
	C-V technique (0.5)	
4	Metal-insulator-semiconductor junctions	
	(a) MOS capacitor, quantitative analysis of a flat band device, C-V	
	characteristics (4.5)	
	(b) MOS capacitor: deviations from flat band conditions (2.5)	
	(c) Oxide charges: fixed, mobile, trapped and interface-trapped	13
	charges (1)	
	(d) MOSFET (5)	
	(e) Fin-FET	
	MOSFET: Architecture for creating simple Boolean logic, memory	
	Dopant density profiling using CV (already discussed in section 3 above)	
5	Defects in Semiconductors	4
	a. Defects as recombination-generation centres or traps-levels (0.5)	
	b. Defect density:	
	Capacitance measurements (C-t): Steady and transient measurement	

	(0.5)		
	Curren	t measurement (I-t) (0.5)	
		Deep Level Transient Spectroscopy (DLTS) (2.5)	
6	Charge	Carrier Life time and diffusion length: Why important?	5
	Op	otical methods	
	a.	Generation and Recombination life time, Surface generation and	
		recombination velocity (0.5)	
	b.	Photoconductance decay (0.5)	
	c.	Short circuit current and Open-circuit voltage decay (1)	
	d.	Photoluminescence Decay (0.5)	
	e.	Surface photovoltage(0.5)	
	f.	Electron beam induced current (0.5)	
	El	ectrical methods	
	a.	Diode current-voltage(0.5)	
	b.	Open-circuit voltage decay (0.5)	
	C.	Pulsed MOS capacitor(0.5)	
Total			42
lectures			

MSE631

Electroceramic Materials and Applications

Course structure and Credits: 3-0-0-4
Prerequisite: MSE303

Course Objective:

The objective of this course is to provide an advanced understanding of electroceramic based materials. It is intended to give the material scientist an understanding of the physics behind the important electroceramic materials. State-of-the-art problems and challenges are discussed to give students a better appreciation of a fast moving field. The course is complemented with a critical assessment of classical papers and review articles to provide an in depth perspective for the student.

Reference Books:

- 1 L.L. Hench and West, Electroceramics, Wiley
- 2 D. M. Smyth, "The Defect Chemistry of Metal Oxides", Publisher: Oxford University Press, ISBN10: 0195110145
- 3 Wei Gao and Nigel M. Sammes, "An Introduction to Electronic and Ionic Materials," Publisher: World Scientific.
- 4 A.J. Moulson & J. M. Herbert, "Electroceramics: Materials, Properties, Applications", Publisher: Wiley
- 5 M. W. Barsoum, "Fundamentals of Ceramics", Publisher: Institute of Physics
- 6 "Impedance Spectroscopy: Theory, Experiment and Applications", Edited by J. Ross Macdonald & Evgenij Barsoukov, Publisher: John Wiley and Sons.
- 7 Robert Huggins, "Use of defect equilibrium diagrams to understand minority species transport in solid electrolytes", Solid State Ionics, 143 (2001) 3-16.
- 8 "CRC Handbook of Solid State Electrochemistry", Edited by P. J. Gellings & H. J. M. Bouwmeester, Publisher: CRC Press
- 9 Jaffe B., Cook W. R. and Jaffe H., "Piezoelectric Ceramics," Academic Press, New York, (1971)
- 10 Principles and applications of ferroelectrics and related materials, M. Lines & A. Glass, Oxford University Press, New York
- 11 Properties of Materials: Anisotropy, Symmetry, Structure, Robert E. Newnham
- 12 Ferroelectric Crystals, Franco Jona & G. Shirane
- 13 Solid State Physics, A.J. Dekker
- 14 Physical ceramics: Yet-Ming Chiang, Dunbar P. Birnie, W. David Kingery, Wiley
- 15 Introduction to Ceramics by WD Kingery, Wiley

SI.No.	TOPICS	Number of Lectures
Structures of common electroceramic oxides	Introduction, FCC packed structures (MgO, CeO ₂ etc), HCP packed structures (LiNbO ₃ etc), Other structures such as Perovskite (BaTiO ₃ etc) and Rutile structures	3
Introduction to Defects and Thermodynamics	Defects in Elemental Solids and Ionic Compounds, Defect Classes, Point Defects, Kröger-Vink Notation, Point	10
	Defect Formation & Equilibrium, Law of Mass- Action and electrical neutrality, Thermodynamics of Intrinsic Defects and Defect Reactions.	
Defect Complexes and Associates	Complexes Containing an Impurity Center and an Ionic Defect, Intrinsic Ionic Defect Associates and Effect of Impurities on the Concentration of Defect Complexes and Associate.	
Defect Equilibria and Brouwer Diagrams	Defect Equilibria in Pure and Stoichiometric Compounds with Schottky Defects, Frenkel Defect Pairs and Intrinsic Ionization of Electrons, Defect Equilibria in Non-stoichiometric Oxides (Cases of oxygen and metal deficiency, oxygen and metal excess), Brouwer Diagrams for selected materials such as YSZ, Undoped and Doped CeO ₂ , TiO ₂ and BaTiO ₃ .	
Ionic and Electronic Transport	Basic Concepts of Diffusion, Tracer Diffusion, Self Diffusion, Chemical Diffusion, Ambipolar Diffusion, Ionic Conduction in Crystalline Solid, Intrinsic and Extrinsic Ionic Conduction, Transference Number, Nernst-Einstein Relationship, and Conductivity- Diffusion Relationship, Polaron theory, metal-ceramic interfaces and electronic transport into and through a dielectric material, Conduction mechanism in terms of Mott insulators, semiconductors, Measurement techniques, Examples of ionic transport, in important	8

	applications	
Theory of Linear Dielectrics	Basics of dielectrics, Clausius-Mossotti Relationship, Polarization mechanisms (Electronic, atomic dipole, space charge polarization) and estimation of polarizabilities:, Frequency Dependence of permittivity and dielectric Loss, Intrinsic and extrinsic contributions to polarization, Relaxation phenomena: Debye equations, Cole-Cole plots, Impedance spectroscopy, Dielectric breakdown and degradation	7
Non-linear dielectrics	Polar and nonpolar ceramics: Crystal structure and Noncentrosymetricity, Tensor representation of properties, Piezoelectrics, Pyroelectrics, Ferroelectrics, Antiferroelectrics, Relaxors Phenomenological theory (phase transitions) and soft mode theory, domain switching and domain-dynamics., Measurement methods, Applications	7
Thermoelectric Oxides	See-back and Peltier effect, materials and applications	1
Magnetic Ferrites	Ferrites structure and properties and their applications	2
Multiferroics and Magnetoelectrics	Principles, Classification, Magnetoelectric Coupling, Materials, Issues and Possible Applications	2
Superconductors	Basic theory, Oxide superconductors such as YBCO, Applications	1
Total		41

MSE693N

Materials Science Technologies for Applications in Life Sciences

Course structure and Credits: 3-0-0-4
Prerequisite: Consent of Instructor

Objectives

The basic objective of the course is to expose the participants to the advancement in materials science targeted for life sciences applications. The course will cover proteins and DNA concepts, advancement in materials science and nanotechnology targeted for life sciences application, and integration of life sciences and materials science for applications like bioMEMS, drug delivery, and biomedical devices. After successful completion of the course, the participants will be expected to know about proteins, DNA, lab-on-a-chip concepts, self assembly, drug delivery, biofunctionalisation of nanomaterials, and several characterization techniques used in life sciences.

References:

- 1. B. Alberts *et al.*, *Essential Cell Biology*. (Garland Publishing Inc., New York, ed. Third, 2009).
- 2. S. S. Saliterman, *Fundamentals of bioMEMS and medical microdevices*. (Wiley-Interscience, Bellingham, 2005).
- 3. T.J. Kindt *et al.*, *Kyby immunology*. (W.H. Freeman, 6th edition 2007)
- 4. C. S. S. R. Kumar, *Biofunctionalization of Nanomaterials*. C. S. S. R. Kumar, Ed., Nanotechnologies for the life sciences (Wiley-VCH, Weinheim, 2006), vol. 1, pp. 366.
- 5. C. S. S. R. Kumar, *Nanomaterials for biosensors*. C. S. S. R. Kumar, Ed., Nanotechnologies for the life sciences (Wiley-VCH, Weinheim, 2006), vol. 8.
- 6. C. S. S. R. Kumar, *Nanosystem characterization tools in the life sciences*. C. S. S. R. kumar, Ed.,

Nanotechnologies for the life sciences (Wiley-VCH, Weinheim, 2005), vol. 3.

7. J. M. Anderson, Annu Rev of Matl Res, **31,** 81 (2001)

Торіс	Lectures
Introduction to integrating nanotechnology and materials science with life sciences	3
Introduction to various size regimes in life science and materials science	
Importance of integration of materials science and engineering with life sciences	
Proteins and DNA: Structure and properties	5
Cells organelles and building blocks of important molecules in cell (1)	
Protein structure, organization, functions with emphasis on antibodies and enzymes, regulation of enzyme activity, protein phosphorylation	
DNA: structure and function of DNA, DNA replication and repair	
Microfabrication techniques and soft lithography; Fundamentals of bio-MEMS, microfluidic devices and Lab-on-chip devices	11
Materials for MEMS	
Photolithography: (single crystal silicon, mask, oxide formation, resist application, baking, exposure, positive and negative resist, developing, etching.	
Etching: Dry Vs wet and isotropic Vs anisotropic, plasma (DC arc and RF), DRIE, wet bulk surface micromachining, 3D structure with sacrificial layer, LIGA	
Deposition: physical and chemical vapour deposition	
Soft fabrication: application of polymers in bio-MEMS, microcontact printing, microtransfer moling, micromolding in capillaries, injection molding, hot embossing	
Biocompatibility	5
Definition of biocompatibility, host response to implanted device, in vivo and in vitro tests for biocompatibility	
Overview of immune system (innntate and adaptive immunity, cell mediated and humoral immunity), B cells, T cells, MHC	
Self assembly: Structure, Mechanism and Applications	5
Difference between self assembly and self organization, example (organothiol molecules on gold substrate)	
Techniques for assembly: microcontact printing, dip pen nanolithography	
Layer by layer self assembly: methods, materials applications	
Application of multilayer biofilm and ultrathin coatings on medical implants	
Biofunctionalization of nano-materials and drug delivery techniques	4
Introduction to advanced drug delivery system, active Vs passive drug delivery	

TOTAL	40
Applications of Materials Science in Life Sciences including sensing, bio-MEMS devices, drug delivery, and biomedical devices using case studies	
Quartz crystal microbalance,	
Atomic Force Microscopy	
Single molecule detection techniques	
Quantum dot labelling	
Fluorescence microscopy	
Overview of characterization techniques:	5
Encapsulation: synthesis and loading of drugs in polyelectrolyte shells, advantages of polyelectrolyte shells	
Protein drugs and challenges in delivery	
systems	

2. Details of the courses other than the three streams

MSE 634 Fundamentals of Spray Techniques

Course structure and credits : 3-0-0-3 Prerequisite: None

Course Contents:

Topic	Distribution	Lectures
Introduction	Different Spray Techniques and their need	2
Thermal Spraying Techniques: Principle and Working	 Combustion Spraying: Flame Spraying D-Gun High Velocity oxy-fuel Arc and Plasma Spraying: Wire/Powder Arc Spraying Plasma Spraying (Air/ Vacuum) Cold Spraying 	12
Spraying Parameters	 In-flight conditions Plasma/ Primary/ Secondary/ Carrier gases Power rating Feed rate Standoff distance Substrate preparation 	6
Powder	 Powder size and distribution Powder Injection Reaction of particles Evaporation/Condensation 	5
Coating Formation	 Comparison of deposition techniques Single Splat Formation Heat transfer and spreading of splat Splay layering and deposition Microstructure and densification of deposited coatings 	6
Diagnostics and Coating Reliability	 Thermal and Kinetic Profiles Inflight particle sensor Control of Deposition parameters Microstructural distribution 	4
Bulk Nanostructure and Near Net Shape	 Design and control of bulk nanostructure Mandrel choice Mandrel removal Case Studies: Thermal Barrier/ Ultra high temperature ceramics 	5

Duration: One semester **Total: 40**

Textbook:

Thermal Spray Fundamentals, Joachim Heberlein, Pierre Fauchais, Maher I. Boulos. Springer (2012)

Reference Books:

- 1. Handbook of thermal spray technology, Joseph R. Davis, ASM International. Thermal Spray Society
 - Training Committee (2004).
- 2. Advanced Structural Ceramics, Bikramjit Basu and Kantesh Balani, Wiley (2011).
- 3. Course materials will be supplemented with handouts, and journal publications.

MSE 658 Dislocations and Plasticity

Course structure and credits: 3-0-0 -4 Prerequisite: Consent of Instructor

Objectives

At the end of the course the student should be able to:

- Have a broad understanding of defects in materials and their role in determining properties of materials.
- Have an overview of plastic deformation mechanisms and the role of dislocations in plasticity, fracture, fatigue and creep.
- Have a thorough understanding of the structure of dislocations in various crystals and their elastic fields.

References

- 6. Introduction to Dislocations, D. Hull and D.J. Bacon, Pergamon Press, Oxford, 1984.
- 7. Theory of Dislocations, J. P. Hirth and J. Lothe, McGraw-Hill, New York, 1968.
- 8. Crystal Defects and Crystalline Interfaces, W. Bollmann, Springer-Verlag, Berlin, 1970
- 9. Elementary Dislocation Theory, J. Weertman and J. Weertman, The MacMillian Company, New York, 1964.
- 10. http://www.tf.uni-kiel.de/matwis/amat/def_en/

	Topic	Lectures
Overview	of defects in Materials	1
- (p	oint, line, planar and volume defects) and their classification.	
- O	verview of plastic deformation mechanisms	
Point defe	ects:	4
- in	teraction and distributions	
- st	atistical thermodynamics	
- ro	le in diffusion and deformation.	
Basic und	erstanding of dislocations using physical and computer models:	4
- th	e Volterra cut	
- Bu	urgers vector and the Burgers circuit	
- th	e line vector	
- ec	lge, screw and mixed dislocations	
- Ro	ple of dislocations in weakening the crystal and in plasticity.	
Elasticity	theory of dislocations:	3
- St	ress, strain and displacement fields and energy of a dislocation	
- Fo	orces on dislocations (including image force)	
- In	teraction between dislocations	
- Co	ore of a dislocation.	
Motion of	dislocations:	5
- Th	ne Peierls stress	
- ro	le of the core structure	
	teraction of dislocations with other defects (including yield point nenomenon);	
- ki	nks; jogs; cross-slip; climb	
- Te	emperature and strain-rate dependence of flow stress	
- Di	slocation dynamics and the tensile stress-strain curve.	
Dislocatio	ns in FCC Metals:	4
- Pa	artial dislocations (Shockley and Frank partials)	
- st	acking faults	
- Th	nompson's tetrahedron	

- Lomer-Cotrell sessile dislocation	
Overview of dislocations in other crystal structures:	2
- HCP metals	
- BCC metals	
- ionic crystals	
- superlattices	
- covalent crystals.	
Origin and multiplication of dislocations:	4
- dislocations in freshly grown crystals	
- nucleation of dislocations	
- multiplication of dislocations (by Frank-Read sources, cross slip and climb)	
- Grain boundary sources	
- Recovery and recrystallization.	
Geometrically/structurally necessary dislocations:	5
- low-angle & general grain boundaries	
- indentation	
- interfacial dislocations	
- Twinning including incoherent twins.	
Specific examples of role of dislocations and case studies:	8
- Dislocations in nanocrystals	
- The Hall-Petch relation and the Inverse Hall-Petch Effect (IHPE)	
- Dislocations in epitaxial systems	
- Severe Plastic deformation	
- Role of dislocations in Creep, Fatigue and Fracture	
TOTAL	40

MSE 664 Solid State Ionics

Course structure and credits: 3-0-0-4 Pre-requisite: none

Course Contents: Perfect Structure, Defects in Elemental Solid and Ionic Compound, Defect Classes, Point Defects, Kröger-Vink Notation for Point Defects, Point Defect Formation & Equilibrium, Law of Mass-action, Thermodynamic Related to Intrinsic Defects and Defect Reactions. Complexes Containing an Impurity Center and an Ionic Defect, Intrinsic Ionic Defect Associates and Effect of Impurities on the Concentration of Defect Complexes and Associate. Basic Concepts of Diffusion, Tracer Diffusion, Self Diffusion, Chemical Diffusion, Ambipolar Diffusion, Ionic Conduction in Crystalline Solid, Intrinsic and Extrinsic Ionic Conduction, Transference Number, Nernst-Einstein Relationship, and Conductivity- Diffusion Relationship. Defect Equilibria in Pure and Stoichiometric Compounds with Schottky Defects, Frenkel Defect Pairs and Intrinsic Ionization of Electrons, Defect Equilibria in Non-stoichiometric Oxides such as Oxygen Deficient Oxide, Oxide with excess Metal, Metal Deficient Oxide, Metal Oxide with Excess Oxygen. Brouwer Diagrams for YSZ, Undoped and Doped CeO₂, TiO₂ BaTiO3. Electrical Characterization Techniques such as AC Electrochemical Impedance Spectroscopy, Four Point Probe D.C. Method, Van Der Pauw Method, I-V Curves, Blocking Electrodes, and Hebb-Wagner Method. Open Circuit Potential, Efficiency, Nernst Equation Analysis, Activation Losses (Tafel Equation), Ohmic Losses, Concentration Description Losses. of Operation, Configurations, Components, Materials Requirements, Manufacturing Techniques, and Performance of the following electrochemical devices such as Solid Oxide Fuel Cells, Gas Sensors and Batteries.

1. Description about Defects and Defect reactions	[4]
2. Defect Complexes and Associates	[3]
3. Ionic Transport	[6]
4. Defect Equilibria and Brouwer Diagrams	[13]
5. Electrical Characterization Techniques	[6]
6. Solid State Electrochemical Devices	[8]

Reference

Books

1 D. M. Smyth, "The Defect Chemistry of Metal Oxides", Publisher: Oxford University Press, ISBN10: 0195110145

- 2 A.J. Moulson & J. M. Herbert, "Electroceramics: Materials, Properties, Applications", Publisher: Springer
- 3 M. W. Barsoum, "Fundamentals of Ceramics", Publisher: Institute of Physics
- 4 "Impedance Spectroscopy: Theory, Experiment and Applications", Edited by J. Ross Macdonald
 - & Evgenij Barsoukov, Publisher: John Wiley and Sons.
- 5 Robert Huggins, "Use of defect equilibrium diagrams to understand minority species transport in solid electrolytes", Solid State Ionics, 143 (2001) 3-16.
- 6 "CRC Handbook of Solid State Electrochemistry", Edited by P. J. Gellings & H. J. M. Bouwmeester, Publisher: CRC Press
- 7 "High Temperature Solid Oxide Fuel Cells, Fundamental, Design and Applications", Edited by Subhash C. Singhal & Kevin Kendall, Publisher: Elsevier
- 8 "Physical Chemistry of Ionic Materials: Ions and Electrons in Solids", Joachim Maier, Wiley, ISBN: 978-0-470-87076-1

MSE676 Materials Failure: Analysis and Prevention

Course structure and credits: 3-0-0-4 Prerequisite: Consent of Instructor

Course Objective: Materials failure has to be understood through a systematic analysis so that the weak link in the design-fabrication-performance chain can be identified and efforts in control/prevention of failures can be implemented. Failure analysis has grown over the year by trying to answer basic questions like: Why materials failure occurs? Can we predict failures? How best one can prevent common failures? etc.

Failure analysis is a fascinating subject as probing failures calls for application of a wide range of ideas and techniques in 'Materials Science and Engineering'. This course intends to be a 'Primer' to an highly applied field involving many technical concept and sophisticated experimental techniques. Many illustrative and interesting cases studies will be considered to give a comprehensive feel about the topic.

TOPICS	Lectures
Engineering Aspects of Failure and Failure Analysis General Practice in failure Analysis: Categories of failure, Importance of failure prevention	2
Tools and techniques in failure analysis: General Practices, Photography, X-rays techniques, Mechnical property evaluations, Metallographic techniques, Fractography, Non-destructuive testing technique	6
Failure mechanisms and modes: Fracture modes, Ductile fracture of metallic materials and their interpretations, factors affecting ductile-brittle relationships. (2 Lectures) Brittle fracture in normally ductile metallic alloy, microstructural aspects of brittle fracture (1 Lectures) Failure characteristics of Ceramics and Plastics (2 Lectures) Fatigue fracture, macroscopic and microscopic characteristics, statistical aspects of fatigue, Fatigue failure prediction and life assessments (2 Lectures) Wear Failures and Prevention. (2 Lectures) Corrosion related failures, Stress corrosion cracking, Hydrogen damage and embrittlement, Biological corrosion failures. (2 L) Elevated temperature failures, creep and stress rupture, metallurgical instabilities (2 L) Distortion failures and deformations (1 Lectures)	12
Examples of engineering failure Improper processing practice: Casting, metal working, welding, etc., Improper heat treatment: Gears, locomotive axle, shafts, etc. Improper design: Tools and dies, integrated circuits etc. Unanticipated service conditions: lifting equipment, reactors, etc. Improper material selection: Orthopedic implants, pressure vessels etc. Improper service condition: Pipelines, mechanical fasteners etc. Comprehensive failure analysis illustration	12 6
At least two cases based on aircraft crash, ship sinking, boiler blast, space mission failure, industrial catastrophe etc. (6 hours)	U
Total Lectures	40

Reference books:

- 1. Source book in failure analysis, American Society of Metals, Metals Park, Ohio, 1974.
- 2. Understanding how components fail, D.J Wulpi, ASM International, The Materials Information Society, 1999.
- 3. A.J. McEvily, Metal Failures: Mechanisms, Analysis, Prevention, John Wiley and Sons, 2002.
- 4. Practical engineering failure analysis, H.M. Tawancy, A. Ul-Hamid and N.M. Abbas, Marcel Dekker, New York, 2004.
- 5. Failure analysis and prevention, Volume 11, ASM Handbook, The Materials Information Society, 2002.
- 6. Failure analysis of engineering structures: Methodology and case histories, V. Ramachandran, A.C. Raghuram, R.V. Krishnan and S.K. Bhaumik, ASM International, 2005.
- 7. Failure analysis of Engineering Materials, Charles R. Brooks and Ashok Choudhury.

MSE682

Computer Simulations in Materials Science

Course structure and Credits: 3-0-0-4 Prerequisite: Consent of the instructor

Course objectives:

Objective of the course is to introduce students to the field of computational materials science. The course commences with a brief discussion of basic physics and numerical methods, essential for the rest of the course. The topics are divided into two major categories, classical and quantum mechanical simulation techniques. The first part focuses primarily on two popularly used methods, molecular dynamics and Monte Carlo; discussing basic theory, applications and examples related to materials science. The second part focuses on density functional based tight binding (DFTB) method. Basic applications, such as simple band structure calculation and geometry optimization and advanced topics such as electron transport calculations will be discussed.

Suggested reading/Text books:

- 1. Molecular dynamics simulation: Elementary methods, J. M. Haile (Wiley Professional).
- 2. The art of molecular dynamics simulation, D. C. Rapaport (Cambridge University Press).
- 3. Computer simulation of liquids, Allen and Tildesley (Oxford).
- 4. Computational materials science: an introduction, June Gunn Lee (CRC Press).
- 5. Electronic structure: basic theory and practical mehtods, Richard Martin (Cambridge).

Introduction to computational materials science, relevance and scope Necessary background Brief overview of classical, statistical & quantum mechanics and mathematical methods Interaction potentials - pair potential, empirical potential MD under different constraints like NVE, NVT and NPT MD simulation of thin film growth and crack propagation Non-equilibrium molecular dynamics MD simulation of phonon mean free path and thermal conductivity Introduction to MC methods Monte Carlo simulation of surface adsorption Monte Carlo simulation of grain growth Carlo simulation of grain growth Quantum-Mechanical calculations Tight binding model and simple band structure calculations Density functional based tight binding (DFTB) method Applications: band structure of metal, insulator and semiconductor Applications: transport calculation Applications: transport calculation Density functional theory (DFT)	Topic	No. of lectures
Brief overview of classical, statistical & quantum mechanics and mathematical methods Molecular dynamics (MD) and Monte Carlo (MC) methods Interaction potentials - pair potential, empirical potential MD under different constraints like NVE, NVT and NPT MD simulation of thin film growth and crack propagation Non-equilibrium molecular dynamics MD simulation of phonon mean free path and thermal conductivity Introduction to MC methods Monte Carlo simulation of surface adsorption Monte Carlo simulation of grain growth Cuantum-Mechanical calculations Tight binding model and simple band structure calculations Tight binding model and simple band structure calculations Applications: band structure of metal, insulator and semiconductor Applications: geometry optimization Applications: transport calculation Density functional theory (DFT)	Introduction to computational materials science, relevance and scope	1
 Interaction potentials - pair potential, empirical potential MD under different constraints like NVE, NVT and NPT MD simulation of thin film growth and crack propagation Non-equilibrium molecular dynamics MD simulation of phonon mean free path and thermal conductivity Introduction to MC methods Monte Carlo simulation of surface adsorption Monte Carlo simulation of grain growth Monte Carlo simulation of grain growth Quantum-Mechanical calculations Tight binding model and simple band structure calculations Density functional based tight binding (DFTB) method Applications: band structure of metal, insulator and semiconductor Applications: geometry optimization Applications: transport calculation Density functional theory (DFT) 	Brief overview of classical, statistical & quantum mechanics and mathematical	5
 Tight binding model and simple band structure calculations Density functional based tight binding (DFTB) method Applications: band structure of metal, insulator and semiconductor Applications: geometry optimization Applications: transport calculation Density functional theory (DFT) 	 Interaction potentials - pair potential, empirical potential MD under different constraints like NVE, NVT and NPT MD simulation of thin film growth and crack propagation Non-equilibrium molecular dynamics MD simulation of phonon mean free path and thermal conductivity Introduction to MC methods Monte Carlo simulation of surface adsorption 	4 2 2 2 4 2
Total no. of loctures 40	 Tight binding model and simple band structure calculations Density functional based tight binding (DFTB) method Applications: band structure of metal, insulator and semiconductor Applications: geometry optimization Applications: transport calculation Density functional theory (DFT) 	2 4 2 2 2

MSE684A

Course Name: Introduction to Advanced Microelectronics Packaging

Credits: 3-0-0-9

Prerequisites: Some basic knowledge of phase diagrams, Consent of the instructor

Course Objective: This course will introduce students to advanced microelectronics packaging along with different packaging architectures. The students will learn the fundamentals of package design and the impact of materials and processes used in manufacturing microelectronics packages. Additionally, the course will also cover the reliability challenges and failure analyses techniques involved in the packaging. Finally, specialized applications of microelectronics packaging like automotive, bioelectronics, flexible electronics etc., will be covered.

References:

- 1. Tummala, R.R., 2019. Fundamentals of Device and Systems Packaging: Technologies and Applications. McGraw-Hill Education.
- 2. Greig, W., 2007. Integrated circuit packaging, assembly and interconnections. Springer Science & Business Media.
- 3. Morris, J.E., 2018. Nanopackaging. Springer, Cham.
- 4. Bath, J. ed., 2020. Lead-free Soldering Process Development and Reliability. John Wiley & Sons.
- 5. Suhir, E., Lee, Y.C. and Wong, C.P. eds., 2007. Micro-and opto-electronic materials and structures: physics, mechanics, design, reliability, packaging.
- 6. Selected research papers

Course Contents:

S. No	Topics	Number of Lectures
1	Microelectronics Packaging Architectures	
	History of microelectronics packaging	4
	Moore's law for packaging, 2.5D and 3D packaging technologies	
2	Design Aspects of Packaging	3
	Electrical design for signal, power, and electromagnetic interference	3

	Heat transfer in packaging	
	Warpage management through design and materials	
3	Wafer Level Processes and Materials	
	Die backside metallization	3
	Die prep processes and adhesive tape and wafer coat materials	
4	Substrate Level Processes and Materials	
	Basics of ceramics, glass, organic, and silicon package substrates	
	Passive components	7
	Chip-to-package interconnections and assembly	
	Underfill and mold materials chemistry and process	
6	Surface Mount Technology (SMT)	
	Solder materials including Sn-Pb, SAC, SnBi, and high-reliability solders	3
	PCB design and SMT process optimization	
7	Reliability Challenges	
	Thermomechanical and drop-shock reliability	4
	Current stressing and electromigration driven failures	
8	Relevance of Different Characterization Techniques in Packaging	
	Microscopy, Surface characterization, physical properties measurements techniques	2
9	Specialized Applications of Packaging	6
	Packaging technologies for applications in automotive, bioelectronics, flexible electronics, smartphones, etc.	
10	Overview of Recent Advancements in Packaging Through the Latest Literature	8

Course Name: Creep and High Temperature Deformation of Materials

Credits : 3-0-0-0(9) Course No. : MSE627A

Prerequisite: Consent of the instructor

Objectives:

The objective of the course is to provide a comprehensive understanding of the creep and high-temperature deformation of materials. The course intends to meet the needs of researchers and scholars in the general area of creep and high-temperature plasticity by covering their fundamental concepts and engineering applications. Apart from emphasizing the structure-property correlation, the course also provides exposure to state-of-the-art knowledge, advanced techniques, modeling, and newer creep resistant materials. The selected case studies discussed in the course will help apply the scientific understanding to the application part. The course will also include some laboratory demonstrations of the phenomena discussed in class together with an appropriate analysis of the data. It is expected that after going through this course, a student will be able to comprehend the scientific literature and will be equipped to carry research on these topics.

Contents

Topics	Max. hours of teaching
Introduction	2
Significance in engineering applications, Development of superalloys, Creep resistant alloys, Creep testing: Machines and Components, Creep at constant stress vs constant load, Creep under combined state of stress	
Creep Phenomenology and Mechanisms	
Stages of creep: Primary, Secondary and Tertiary, Dependence of creep rate on stress and temperature, Creep analysis: Empirical, Phenomenological and Micromechanism based	1
Factors influencing creep, Temperature Compensated time, Zener-Hollomon parameter, Activation energy in creep, Temperature jump experiment	2
Role of diffusion, Diffusion pathways, Stress exponent, Stress jump test	1
Independent and Sequential processes	2
Power law creep: Role of dislocations, Natural-three-power law, Five-power-law, Influence of the elastic modulus and stacking fault energy	2
Viscous theories of creep: Nabarro-Herring creep, Coble creep, Accommodation processes, Grain boundary sliding, Harper-Dorn Creep	3
Microstructure factors affecting creep, Grain size effect, Inverse grain size exponent	1
Substructural changes during creep, Subgrain formation and models, Influence of substructure on creep resistance, Pipe diffusion, Interface controlled diffusion creep	2
Transient creep, Tertiary creep and Creep rupture: Cavity nucleation and growth	3

Creep and high temperature deformation of Advanced Alloys, Intermetallics and Ceramics		
High temperature steels, Particle-strengthened alloys, Titanium alloys, Ni- and Co-base superalloys, Materials for aerospace and nuclear applications		
Creep representation, Life Predication: Methods and Extrapolation models, Modelling of creep		
Deformation mechanism maps, Life prediction methods: Damage rate approach, Parametric-, Analytical- and Extrapolation methods		
Superplasticity		
Phenomemological aspects, Types of Superplasticity, Superplasticity models: Topological and Microstructural, Superplastic materials and applications		
Advanced topics in Creep		
Advanced creep techniques, Creep at small length scales, Creep-Fatigue interaction, Low temperature creep plasticity, Zero-creep experiment, Creep in multiphase alloys		
Case studies and Special topics		
Creep failure of components from aerospace and nuclear power plants		
Creep and Superplasticity in non-equilibrium microstructures	2	
Design of creep resistant materials, Creep data analysis		
Total	40	

References

- 1. F.R.N. Nabarro and H. L. de Villiers, The Physics of Creep, Taylor and Francis Ltd., 1995.
- 2. M. Kassner, Fundamentals of Creep in Metals and Alloys, Third Edition, Elsevier, 2015.
- 3. J-S. Zhang, High Temperature Deformation and Fracture of Materials, Woodhead Publishing, 2010.
- 4. J-P. Poirier, Creep of Crystals, Cambridge University Press, 2009.
- 5. K. Naumenko and H. Altenbach, Modeling of Creep for Structural Analysis, Springer, 2010.
- 6. H.J. Frost and M.F. Ashby, Deformation-Mechanism Maps: The Plasticity and Creep of Metals and Ceramics, Pergamon, 1982.
- 7. C. T. Sims, N. S. Stoloff, W. C. Hagel, Superalloys II: High-Temperature Materials for Aerospace and Industrial Power, Wiley, 1987.
- 8. M.N. Shetty, Dislocations and Mechanical Behaviour of Materials, PHI Learning Pvt. Ltd., 2013.

Indian Institute of Technology Kanpur

Proposal for a new course

1. Course No.:

2. Course Title: Nanocomposite Thin Films and Applications

3. Credits: 3-0-0-9 **Duration of Course:** Full Semester

4. Proposing Department: MSE

Other Departments which may be interested in the proposed course: EE, PHY, SEE

5. Proposing Instructor: Dr. Shikhar Misra (Other potential instructors: Dr. Anshu Gaur,

Dr. Monica Katiyar, Dr. Anandh Subramaniam)

6. Course Description:

A) Objective: This course will introduce students to thin film science along with the various thin film deposition techniques. The students will learn the thermodynamics of thin film deposition and the critical parameters required for the epitaxial thin film design. Additionally, the course will also cover the various techniques that rely on the use of electrons, photons and sharp tips to learn about different aspects about surfaces, including the structural, optical, and surface techniques used to characterize the thin films. Finally, self-assembled nanocomposite thin film growth will be discussed and its various applications with their microstructure-property correlation will be covered.

B) Content:

S. No	Broad Title	Topics	Lec.
1	Introduction	Overview of thin film technology	2
2	Review	o Crystal structures of thin films	2
		 Defects in thin films (vacancies and interstitials, 	
		dislocations etc.)	
		 Nanocrystalline, polycrystalline and epitaxial thin 	
		films	
3	Interfaces	Thermal dynamics and diffusion	3
		 Interface and surface of thin films 	
4	Growth models	Thin film nucleation and growth models (2D, 3D, and	2
		2D-3D combination)	
5	Thermodynamics	Thermodynamics of thin film growth	2
6 Epitaxy		 Epitaxy: Homoepitaxy and heteroepitaxy 	5
		 Lattice matching epitaxy and domain matching 	
		epitaxy	
		Superlattice structures	
		Strain Engineering	
7	Characterization of	Characterization of epitaxial Thin Films and Surfaces	4
	epitaxial thin films	(XRD, SEM, TEM, SPM, Ellipsometry, XPS)	
8	Vacuum science	Vacuum science and technology	2

9	PVD deposition techniques for epitaxial growth	SputteringPulsed Laser Deposition (PLD)	3
10	Self-assembled nanocomposite thin film growth	Thin film metal oxides, Growth of self-assembled nanocomposites, Oxide-oxide and oxide-metal nanocomposites, vertically aligned nanocomposites, strain compensation model, Lattice mismatch between two phases	4
11	Electrical Properties of nanocomposites	Heckmann Diagram, Functionality coupling, Ferroelectricity, Si integration	2
12	Magnetic Properties of nanocomposites	Ferromagnetism, Magneto-electric coupling, Magneto-optical coupling	2
13	Optical Properties of nanocomposites	Light-Matter interaction, Metamaterials, Optical sensing	2
14	Structure-property correlation	Morphological control of nanocomposite thin films and functionality tuning	2
15	Presentation	Term paper presentation	2

C) Total number of lectures: 39

C) Prerequisites: Basic knowledge of thermodynamics (MSE201)

D) Short summary of the course content: The course is designed for advanced UG and PG students interested in functional materials science. The course begins with reviewing the basic concepts of crystal structures, defects and interfaces relevant to thin films. The course offers an introduction to the epitaxial thin film growth, characterization techniques and self-assembled nanocomposite thin film growth along with their applications.

7. References:

- 1. Materials Science of Thin Films: Deposition and Structure, by M. Ohring, 2002.
- 2. Electronic Thin Film Science for Electrical Engineers and Materials Scientists, by K-N Tu, J.W. Mayer and L.C. Feldman, 1992.
- 3. Elements of X-ray Diffraction, 2nd Edition, by B.D. Cullity, 1978
- 4. Selected research papers

Dated: 08/03/2022	Proposer: Dr. Shikhar Misra	Shikhar Misra
Dated:	DUGC/DPGC Convener:	

The course is approved / not approved

Chairman, SUGC/SPGC

Dated: